

## FEATURES:

- 0.5 MICRON CMOS Technology
- Typical  $t_{SR(o)}$  (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- $V_{CC} = 3.3V \pm 0.3V$ , Normal Range
- $V_{CC} = 2.7V$  to  $3.6V$ , Extended Range
- $V_{CC} = 2.5V \pm 0.2V$
- CMOS power levels ( $0.4\mu W$  typ. static)
- Rail-to-Rail output swing for increased noise margin
- Available in SSOP and TSSOP packages

## DRIVE FEATURES:

- Balanced Output Drivers:  $\pm 12mA$
- Low switching noise

## APPLICATIONS:

- 3.3V high speed systems
- 3.3V and lower voltage computing systems

## DESCRIPTION:

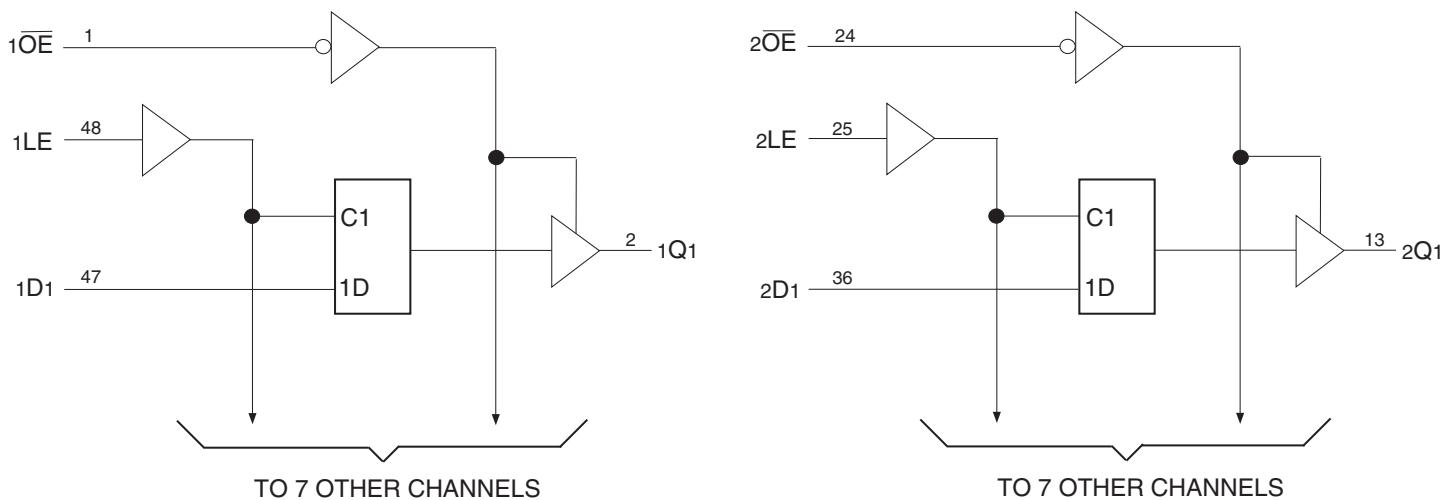
This 16-bit transparent D-type latch is built using advanced dual metal CMOS technology. The ALVCH162373 is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. This device can be used as two 8-bit latches or one 16-bit latch. When the latch enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable ( $\overline{OE}$ ) can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.  $\overline{OE}$  does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The ALVCH162373 has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been designed to drive  $\pm 12mA$  at the designated threshold levels.

The ALVCH162373 has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistor.

## FUNCTIONAL BLOCK DIAGRAM



## PIN CONFIGURATION

1 $\bar{OE}$	1	48	1LE
1Q1	2	47	1D1
1Q2	3	46	1D2
GND	4	45	GND
1Q3	5	44	1D3
1Q4	6	43	1D4
Vcc	7	42	Vcc
1Q5	8	41	1D5
1Q6	9	40	1D6
GND	10	39	GND
1Q7	11	38	1D7
1Q8	12	37	1D8
2Q1	13	36	2D1
2Q2	14	35	2D2
GND	15	34	GND
2Q3	16	33	2D3
2Q4	17	32	2D4
Vcc	18	31	Vcc
2Q5	19	30	2D5
2Q6	20	29	2D6
GND	21	28	GND
2Q7	22	27	2D7
2Q8	23	26	2D8
2 $\bar{OE}$	24	25	2LE

SSOP/ TSSOP  
TOP VIEWABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
VTERM <sup>(3)</sup>	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
TSTG	Storage Temperature	-65 to +150	°C
I <sub>OUT</sub>	DC Output Current	-50 to +50	mA
I <sub>IK</sub>	Continuous Clamp Current, V <sub>i</sub> < 0 or V <sub>i</sub> > V <sub>cc</sub>	±50	mA
I <sub>OK</sub>	Continuous Clamp Current, V <sub>o</sub> < 0	-50	mA
I <sub>CC</sub>	Continuous Current through each V <sub>cc</sub> or GND	±100	mA
I <sub>SS</sub>			

## NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V<sub>cc</sub> terminals.
3. All terminals except V<sub>cc</sub>.

CAPACITANCE (T<sub>A</sub> = +25°C, F = 1.0MHz)

Symbol	Parameter <sup>(1)</sup>	Conditions	Typ.	Max.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0V	5	7	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	7	9	pF
C <sub>I/O</sub>	I/O Port Capacitance	V <sub>IN</sub> = 0V	7	9	pF

## NOTE:

1. As applicable to the device type.

## PIN DESCRIPTION

Pin Names	Description
x <sub>D</sub> x	Data Inputs <sup>(1)</sup>
xLE	Latch Enable Inputs
xQ <sub>x</sub>	3-State Outputs
x $\bar{OE}$	3-State Output Enable Input (Active LOW)

## NOTE:

1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE (EACH 8-BIT SECTION)<sup>(1)</sup>

Inputs			Outputs
x $\bar{OE}$	xLE	x <sub>D</sub> x	xQ <sub>x</sub>
L	H	H	H
L	H	L	L
H	X	X	Z
L	L	X	Q <sub>o</sub> <sup>(2)</sup>

## NOTES:

1. H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Don't Care  
Z = High Impedance
2. Output level before the indicated steady-state input conditions were established.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition:  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ 

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
V <sub>IH</sub>	Input HIGH Voltage Level	V <sub>CC</sub> = 2.3V to 2.7V		1.7	—	—	V
		V <sub>CC</sub> = 2.7V to 3.6V		2	—	—	
V <sub>IL</sub>	Input LOW Voltage Level	V <sub>CC</sub> = 2.3V to 2.7V		—	—	0.7	V
		V <sub>CC</sub> = 2.7V to 3.6V		—	—	0.8	
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> = 3.6V	V <sub>I</sub> = V <sub>CC</sub>	—	—	$\pm 5$	$\mu\text{A}$
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> = 3.6V	V <sub>I</sub> = GND	—	—	$\pm 5$	$\mu\text{A}$
I <sub>OZH</sub>	High Impedance Output Current (3-State Output pins)	V <sub>CC</sub> = 3.6V	V <sub>O</sub> = V <sub>CC</sub>	—	—	$\pm 10$	$\mu\text{A}$
			V <sub>O</sub> = GND	—	—	$\pm 10$	
V <sub>IK</sub>	Clamp Diode Voltage	V <sub>CC</sub> = 2.3V, I <sub>IN</sub> = $-18\text{mA}$		—	-0.7	-1.2	V
V <sub>H</sub>	Input Hysteresis	V <sub>CC</sub> = 3.3V		—	100	—	$\text{mV}$
I <sub>CCL</sub> I <sub>CCH</sub> I <sub>CZZ</sub>	Quiescent Power Supply Current	V <sub>CC</sub> = 3.6V V <sub>IN</sub> = GND or V <sub>CC</sub>		—	0.1	40	$\mu\text{A}$
$\Delta I_{CC}$	Quiescent Power Supply Current Variation	One input at V <sub>CC</sub> - 0.6V, other inputs at V <sub>CC</sub> or GND		—	—	750	$\mu\text{A}$

## NOTE:

1. Typical values are at V<sub>CC</sub> = 3.3V,  $+25^\circ\text{C}$  ambient.

## BUS-HOLD CHARACTERISTICS

Symbol	Parameter <sup>(1)</sup>	Test Conditions		Min.	Typ. <sup>(2)</sup>	Max.	Unit
I <sub>BHH</sub> I <sub>BHL</sub>	Bus-Hold Input Sustain Current	V <sub>CC</sub> = 3V	V <sub>I</sub> = 2V	-75	—	—	$\mu\text{A}$
			V <sub>I</sub> = 0.8V	75	—	—	
I <sub>BHH</sub> I <sub>BHL</sub>	Bus-Hold Input Sustain Current	V <sub>CC</sub> = 2.3V	V <sub>I</sub> = 1.7V	-45	—	—	$\mu\text{A}$
			V <sub>I</sub> = 0.7V	45	—	—	
I <sub>BHHO</sub> I <sub>BHLO</sub>	Bus-Hold Input Overdrive Current	V <sub>CC</sub> = 3.6V	V <sub>I</sub> = 0 to 3.6V	—	—	$\pm 500$	$\mu\text{A}$

## NOTES:

1. Pins with Bus-Hold are identified in the pin description.

2. Typical values are at V<sub>CC</sub> = 3.3V,  $+25^\circ\text{C}$  ambient.

## OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Max.	Unit
VOH	Output HIGH Voltage	Vcc = 2.3V to 3.6V	IOH = - 0.1mA	Vcc - 0.2	—	V
		Vcc = 2.3V	IOH = - 4mA	1.9	—	
			IOH = - 6mA	1.7	—	
		Vcc = 2.7V	IOH = - 4mA	2.2	—	
			IOH = - 8mA	2	—	
		Vcc = 3V	IOH = - 6mA	2.4	—	
			IOH = - 12mA	2	—	
VOL	Output LOW Voltage	Vcc = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
		Vcc = 2.3V	IOL = 4mA	—	0.4	
			IOL = 6mA	—	0.55	
		Vcc = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		Vcc = 3V	IOL = 6mA	—	0.55	
			IOL = 12mA	—	0.8	

## NOTE:

1. VIH and Vil must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range.  
TA = - 40°C to + 85°C.

## OPERATING CHARACTERISTICS, TA = 25°C

Symbol	Parameter	Test Conditions	Vcc = 2.5V ± 0.2V	Vcc = 3.3V ± 0.3V	Unit
			Typical	Typical	
CPD	Power Dissipation Capacitance Outputs enabled	CL = 0pF, f = 10Mhz	19	22	pF
	Power Dissipation Capacitance Outputs disabled		4	5	

SWITCHING CHARACTERISTICS<sup>(1)</sup>

Symbol	Parameter	Vcc = 2.5V ± 0.2V		Vcc = 2.7V		Vcc = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
tPLH	Propagation Delay xDx to xQx	1.5	5.3	1.5	4.5	1.5	4	ns
tPHL	Propagation Delay xLE to xQx	2	5.6	2	5	2	4	ns
tPZH	Output Enable Time xOE to xQx	1.5	6.5	1.5	6	1.5	5	ns
tPZL	Output Disable Time xOE to xQx	1.5	5.6	1.5	5.5	1.5	4.5	ns
tsU	Setup Time, data before LE↓	2	—	2	—	2	—	ns
tH	Hold Time, data after LE↓	1.5	—	1.5	—	1.5	—	ns
tw	Pulse Duration, LE HIGH or LOW	3.3	—	3.3	—	3.3	—	ns
tSK(0)	Output Skew <sup>(2)</sup>	—	—	—	—	—	500	ps

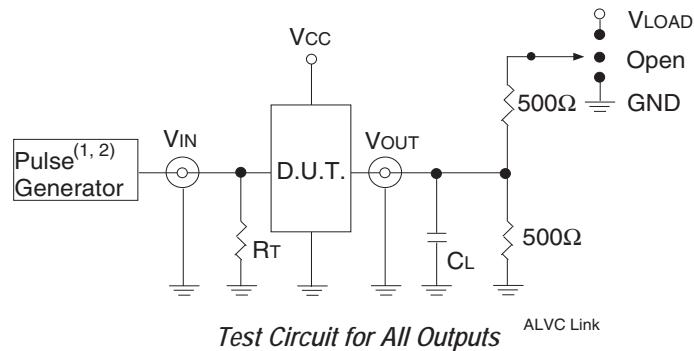
## NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = - 40°C to + 85°C.  
2. Skew between any two outputs of the same package and switching in the same direction.

## TEST CIRCUITS AND WAVEFORMS

## TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(1)} = 2.7V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
$V_{LOAD}$	6	6	$2 \times V_{CC}$	V
$V_{IH}$	2.7	2.7	$V_{CC}$	V
$V_T$	1.5	1.5	$V_{CC} / 2$	V
$V_{LZ}$	300	300	150	mV
$V_{HZ}$	300	300	150	mV
$C_L$	50	50	30	pF



## DEFINITIONS:

$C_L$  = Load capacitance: includes jig and probe capacitance.

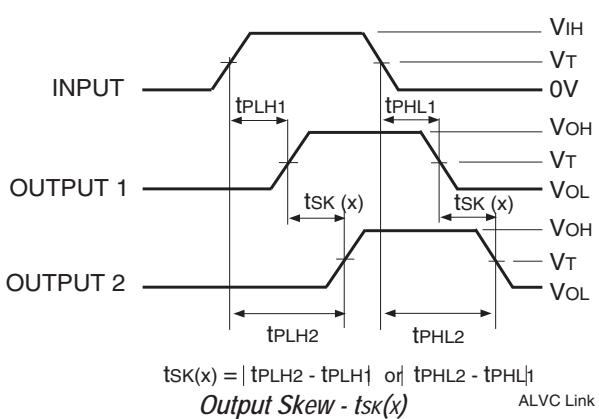
$R_T$  = Termination resistance: should be equal to  $Z_{OUT}$  of the Pulse Generator.

## NOTES:

1. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $t_f \leq 2.5\text{ns}$ ;  $t_r \leq 2.5\text{ns}$ .
2. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $t_f \leq 2\text{ns}$ ;  $t_r \leq 2\text{ns}$ .

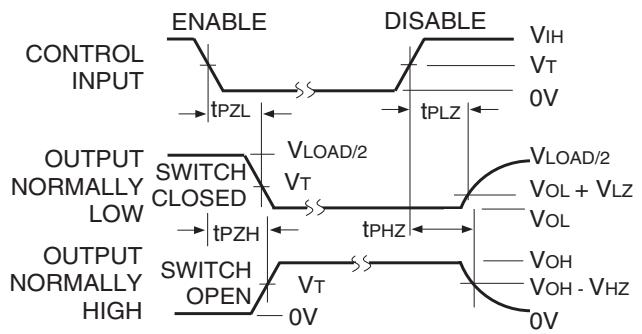
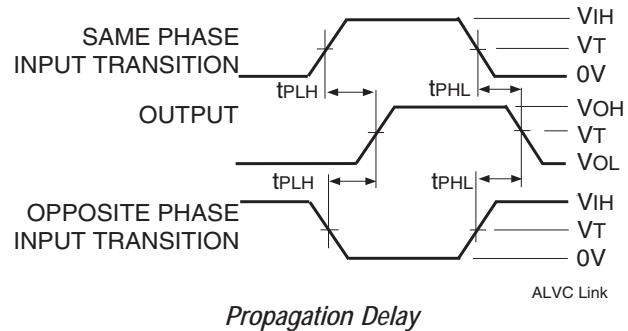
## SWITCH POSITION

Test	Switch
Open Drain	
Disable Low	$V_{LOAD}$
Enable Low	
Disable High	$GND$
Enable High	
All Other Tests	Open



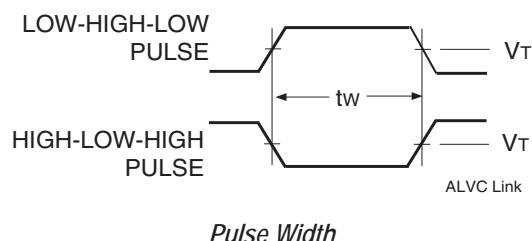
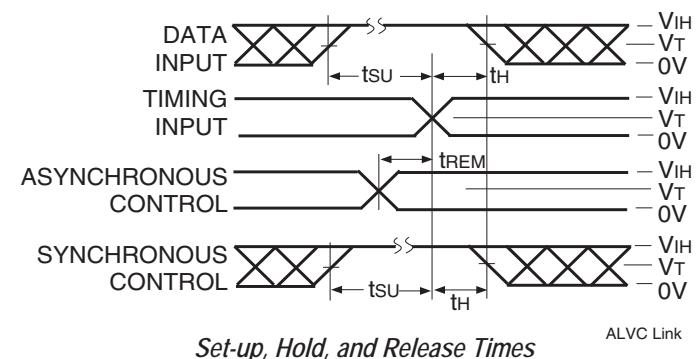
## NOTES:

1. For  $tsk(o)$  OUTPUT1 and OUTPUT2 are any two outputs.
2. For  $tsk(b)$  OUTPUT1 and OUTPUT2 are in the same bank.

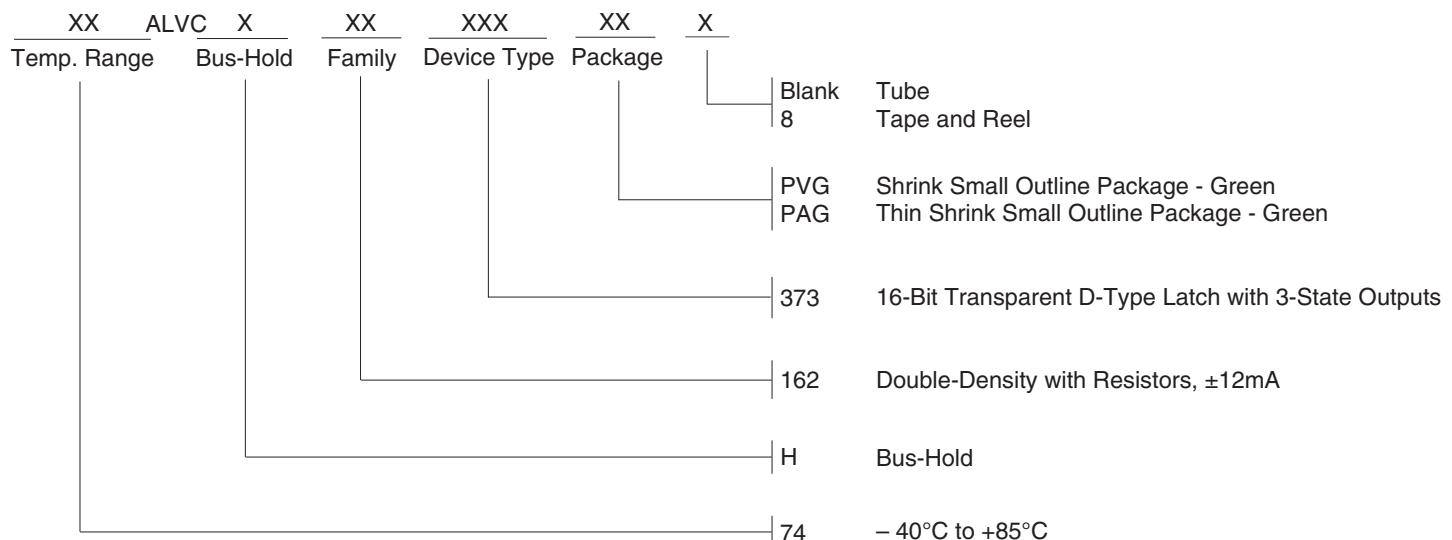


## NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.



## ORDERING INFORMATION



## DATASHEET DOCUMENT HISTORY

06/15/2016 Pg. 6 Updated the ordering information by adding Tape and Reel.

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